

Non-invasive Raman tomography for 2D-material applications

Stefan Wagner¹, Thomas Dieing², Alba Centeno³, Amaia Zurutuza³,
Satender Kataria¹, Max C. Lemme⁴

¹*University of Siegen, Graphene based Nanotechnology*

²*WITec Wissenschaftliche Instrumente und Technologie GmbH*

³*Graphenea S.A.*

⁴*RWTH Aachen, Micro and nanoelectronics*

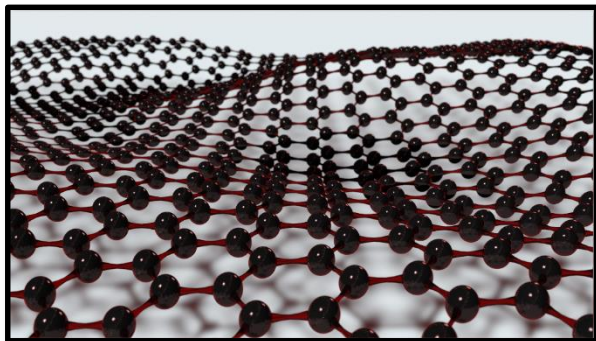
2017-03-30



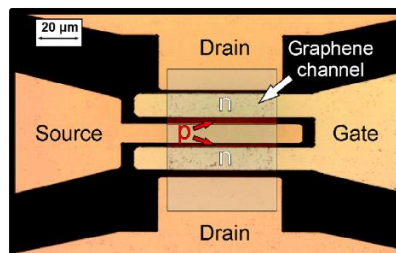
Outline

1. Introduction
2. Device fabrication
3. Raman tomography
4. Other applications
5. Conclusions

2D material device oriented research

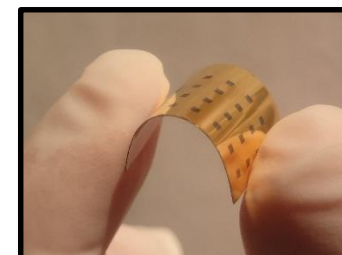


Electronics

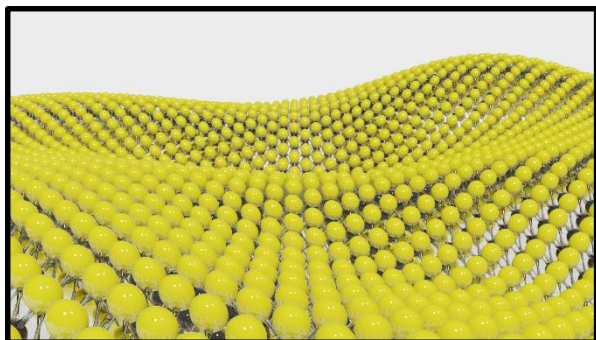


RF graphene transistor [5]

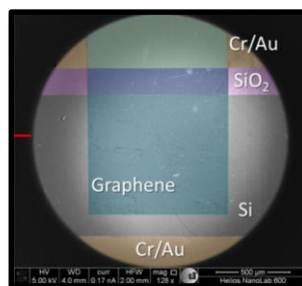
Flexible electronics



Flexible multispectral photodetector [6]

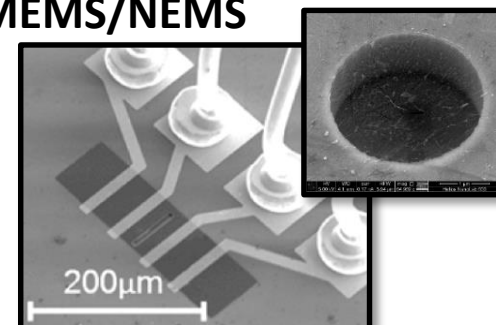


Optoelectronics



2D material/Si photodetector [7]

MEMS/NEMS



Pressure sensor [8],[9]

→ Applications require non-invasive analytics

[1] Schneider, D. et al., accepted for oral presentation, DRC Conference 2016

[2] Riazimehr, Sarah, et al. *Solid-State Electronics*, Selected papers from the EUROSOI-ULIS conference, 115, Part B (January 2016)

[3] Wagner, S., et al. *Microelectronic Engineering*. March, 2016

[4] Pandey, H., et al. In *2016 Joint International EUROSOI-ULIS*, 143–46, 2016.

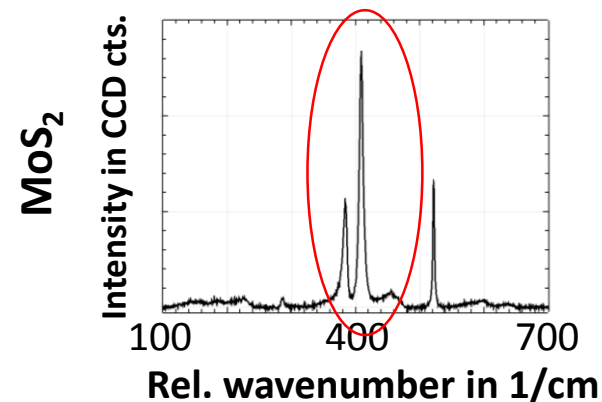
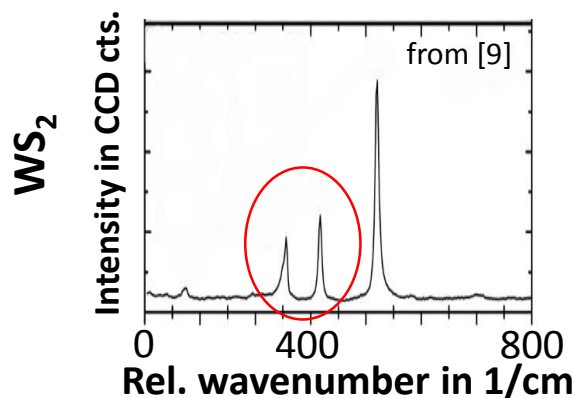
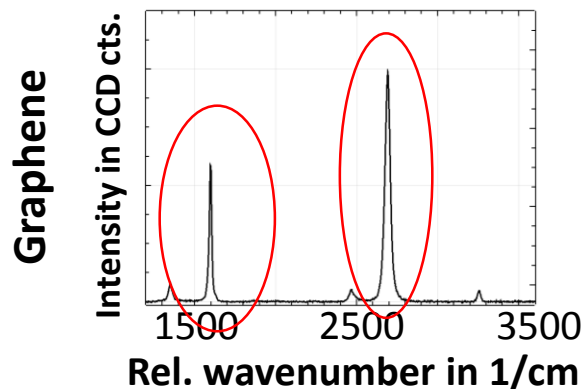
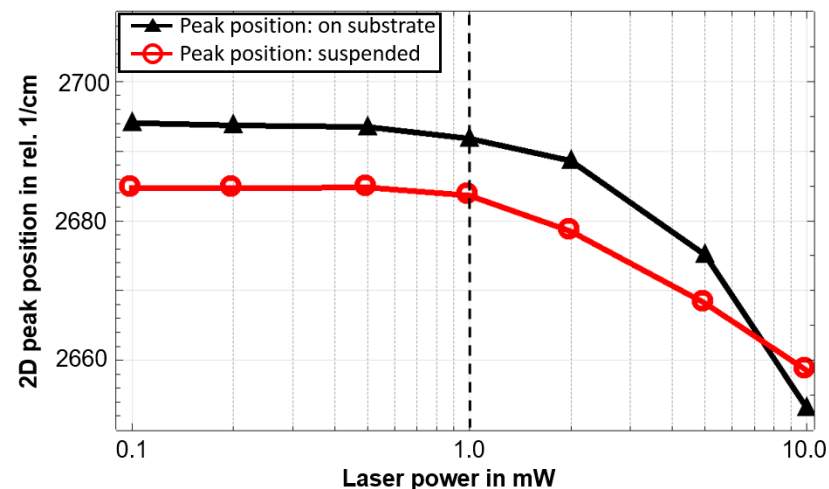
[5] Smith, A. D., et al. *Nano Letters* 13, no. 7 (July 10, 2013)

Raman spectroscopy

2D materials

- Large-area scan possible (step motor and/or piezo stage: from μm up to cm size areas)
- non-invasive
- 2D material spectrum
 - high intensity
 - distinct fingerprint

Graphene laser dependency measurement

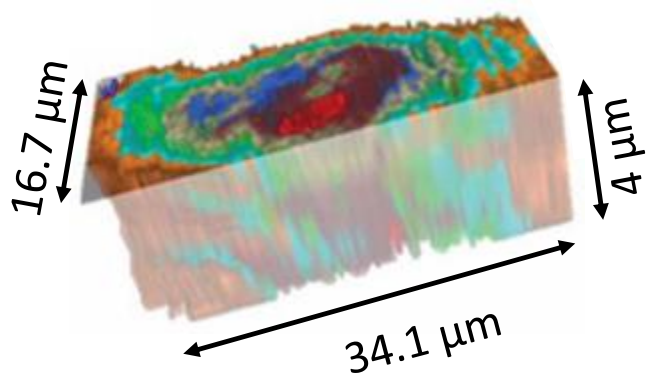


[9] A. Berkdemir *et al.*, *Sci Rep*, vol. 3, Apr. 2013.

Raman spectroscopy 3D-imaging

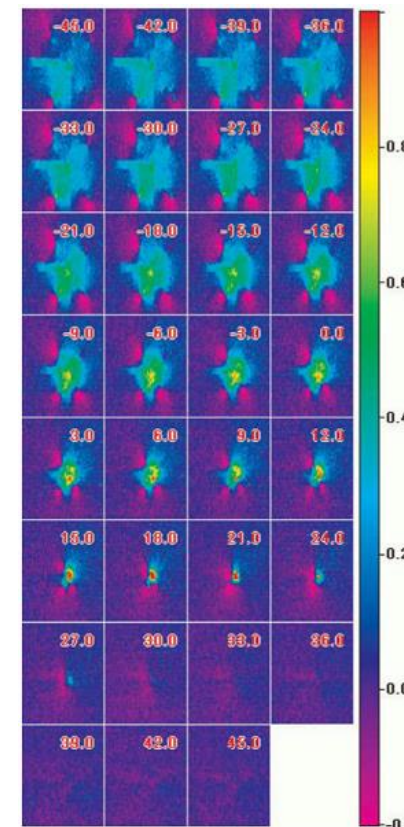
Biology:

Endothelial cells and vascular wall [6]



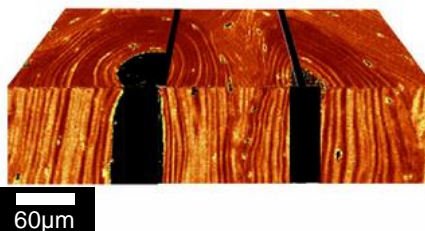
Material science:

Residual strain in diamond single crystals [8]



Biology:

Cortical bones [7]



→ So far not done for semiconductor devices

[6] K. Majzner, A. Kaczor, N. Kachamakova-Trojanowska, A. Fedorowicz, S. Chlopicki, and M. Baranska, *Analyst*, vol. 138, no. 2, pp. 603–610, Dec. 2012.

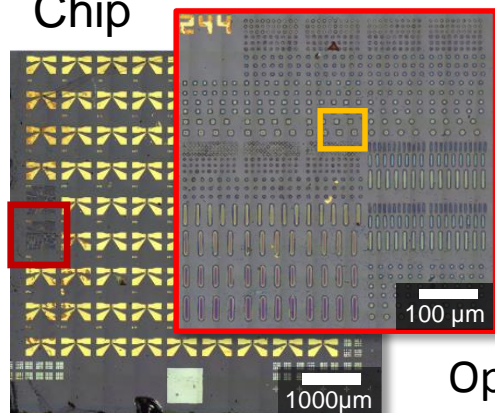
[7] M. Kazanci *et al.*, *Bone*, vol. 41, no. 3, pp. 456–461, Sep. 2007.

[8] A. Crisci, F. Baillet, M. Mermoux, G. Bogdan, M. Nesládek, and K. Haenen, *Phys. Status Solidi A*, vol. 208, no. 9, pp. 2038–2044, Sep. 2011.

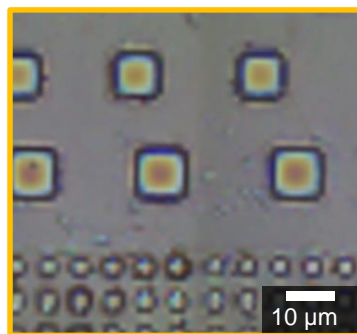
Device fabrication

Test structures

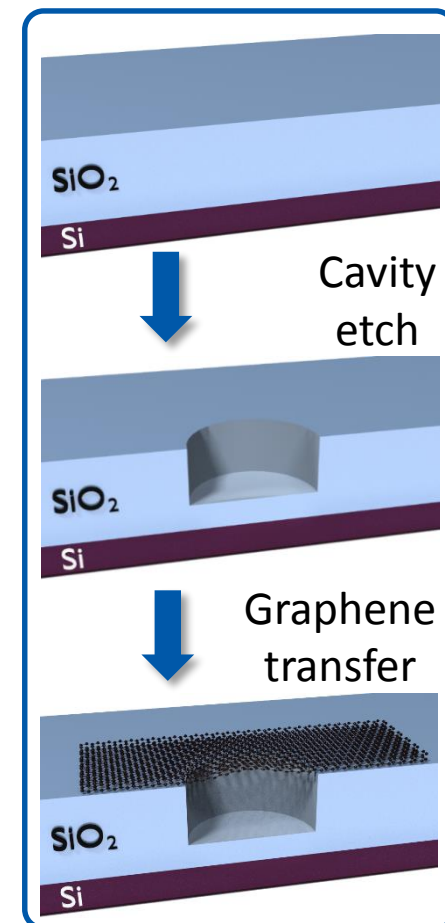
Chip



Optical micrograph



Cross-section of the test structure substrate



Optical micrograph

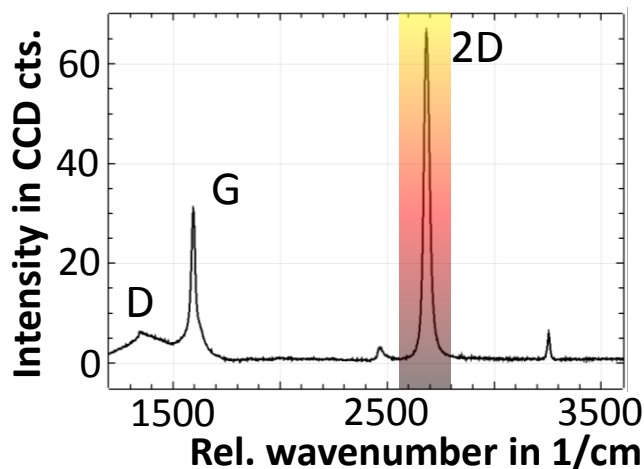
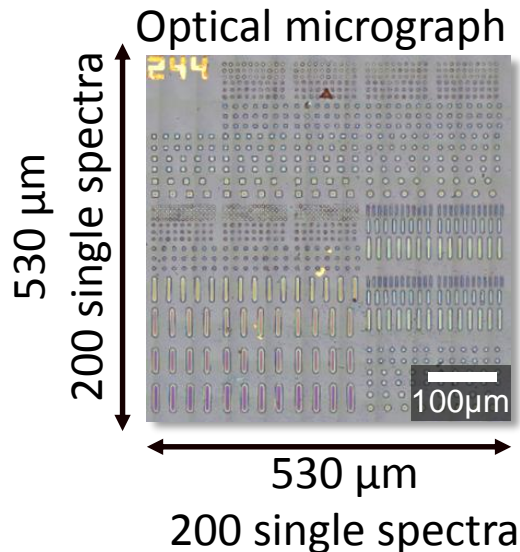
Chip:

- Dimensions: $530 \mu\text{m} \times 530 \mu\text{m}$ (Chip: $7 \text{ mm} \times 7 \text{ mm}$)
- 2x Test structures (+ 79x devices)

Test structures:

- Geometry: round, square and rectangular cavities
- Dimensions: $3 \mu\text{m} - 20 \mu\text{m}$ diameter / edge length

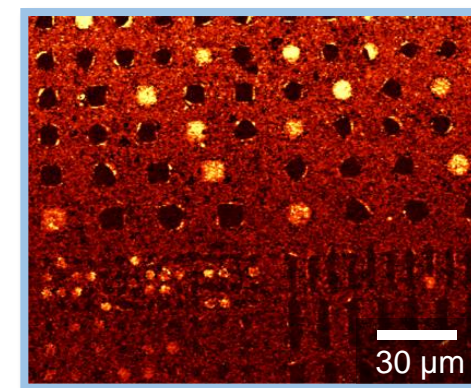
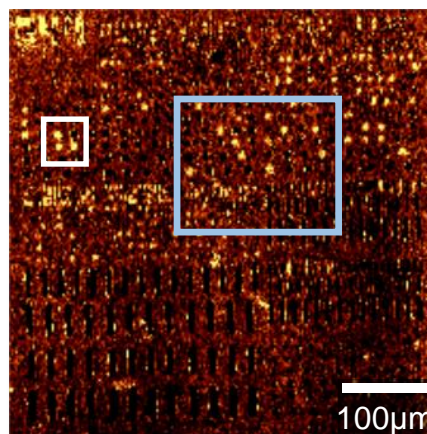
Identification of intact membranes



Single Raman spectrum of graphene from the device.

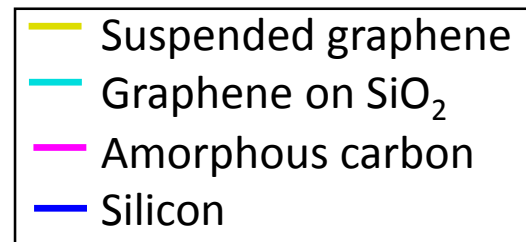
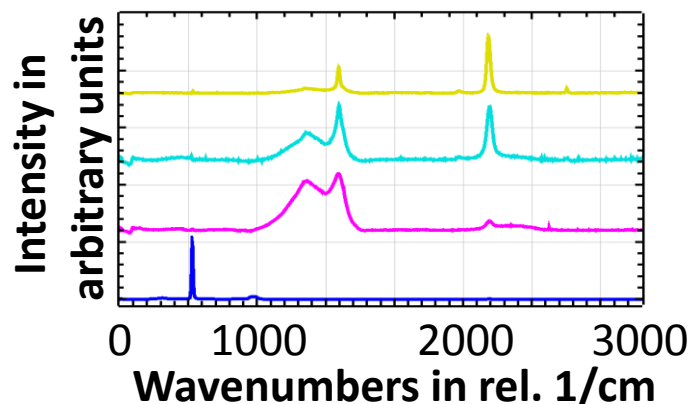
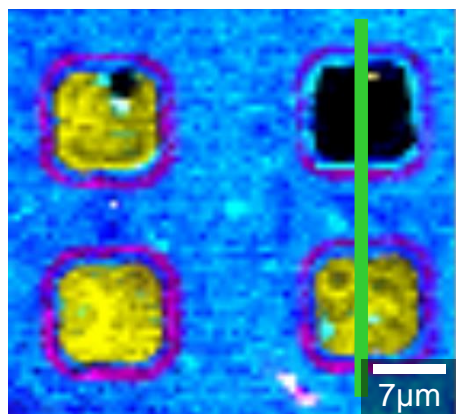
Area scan:

- Scan time: 13 min
- Filtered by the 2D-peak
- Highest intensity
- Easy to identify
- Higher intensity if suspended



2D – peak filtered area maps

Raman tomography

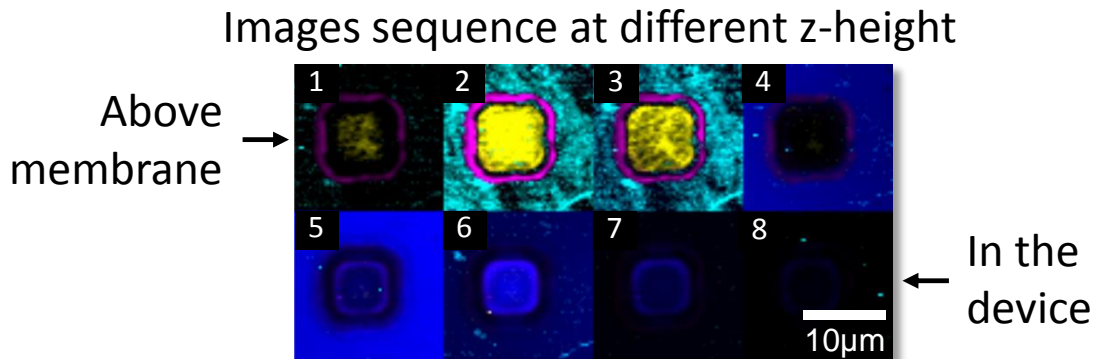
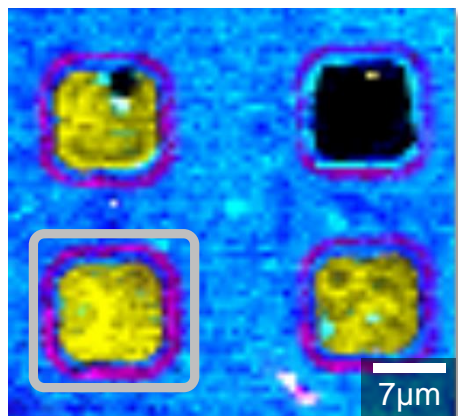


Cross-sectional view

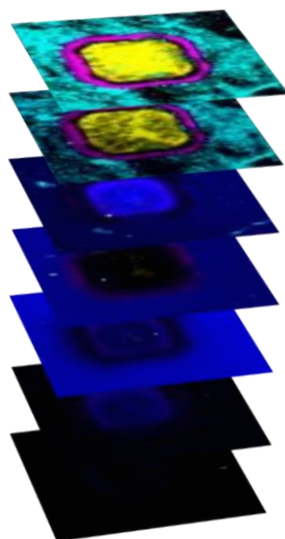


- Resolution: 300 nm lateral, 900 nm vertical
- Scan in z-direction:
 - Start with focus above the sample
 - Focus lowered step by step in z
 - Ending with focus in the sample
- Total 24 x 30 µm line scans

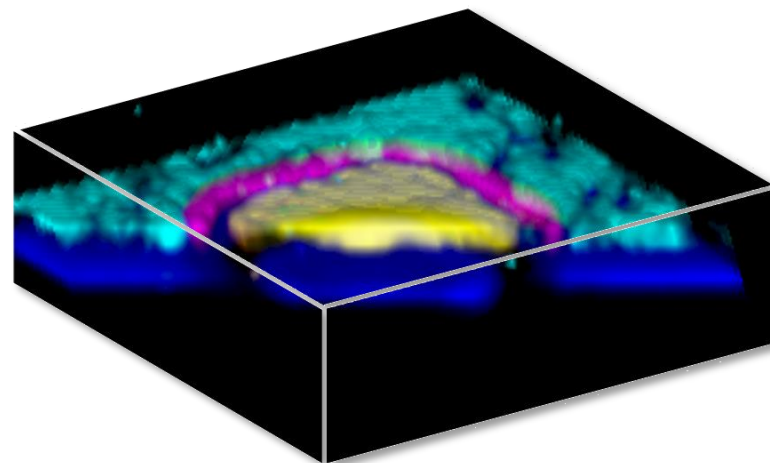
Raman tomography



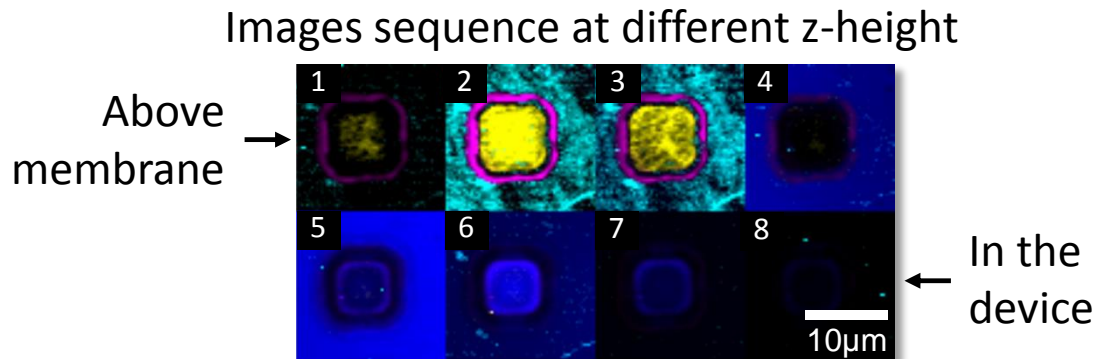
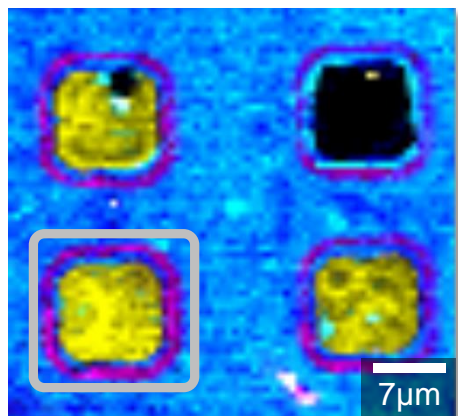
- Resolution: 300 nm lateral, 900 nm vertical
- 8 area scans at different z-height



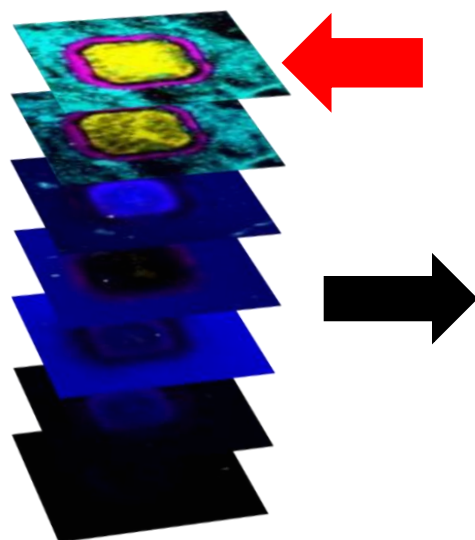
3D Raman tomography image



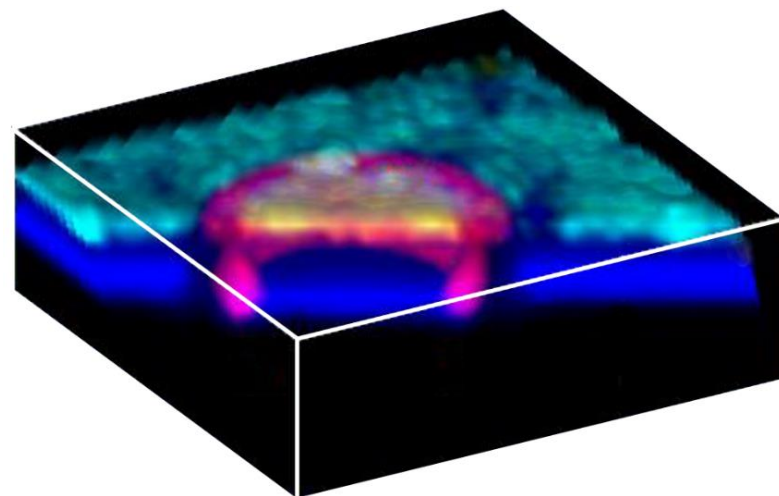
Raman tomography



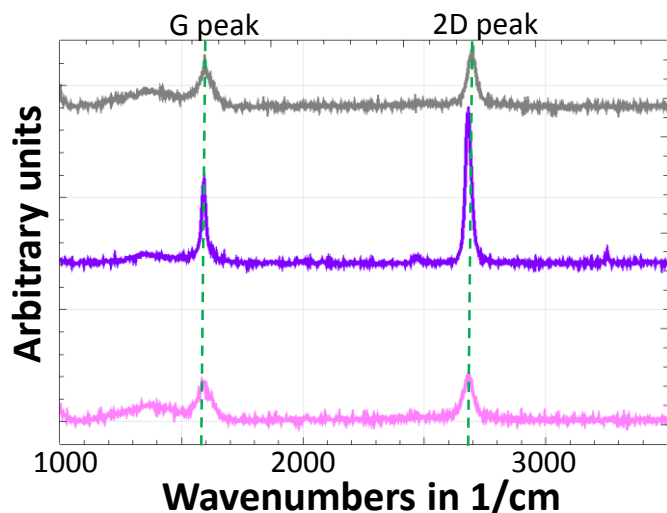
- Resolution: 300 nm lateral, 900 nm vertical
- 8 area scans at different z-height



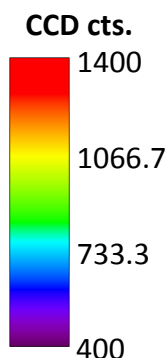
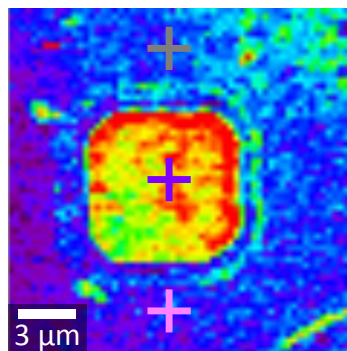
3D Raman tomography image



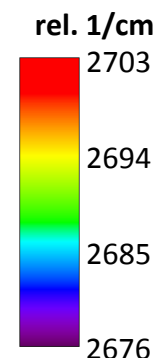
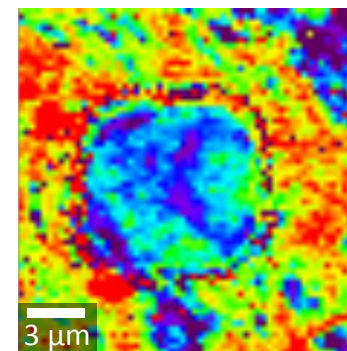
Depth dependent analysis



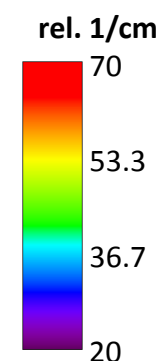
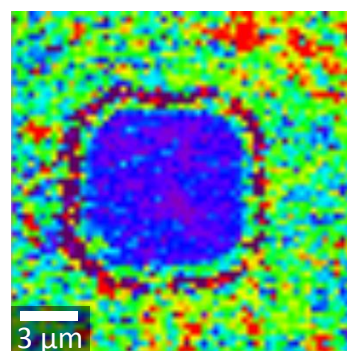
2D Intensity



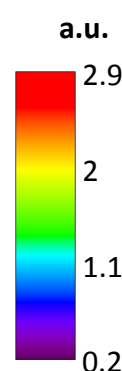
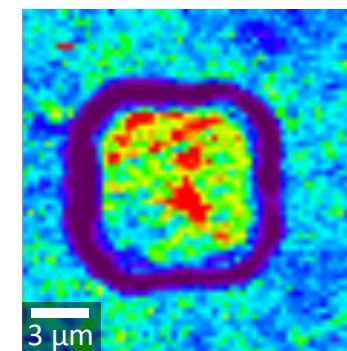
2D Peak position



2D FWHM



I(2D)/I(G) ratio

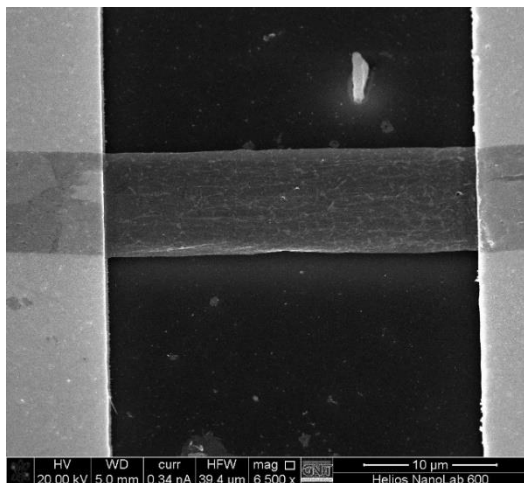


Each layers can be analyzed separately for:

- Strain variations
- Doping variations

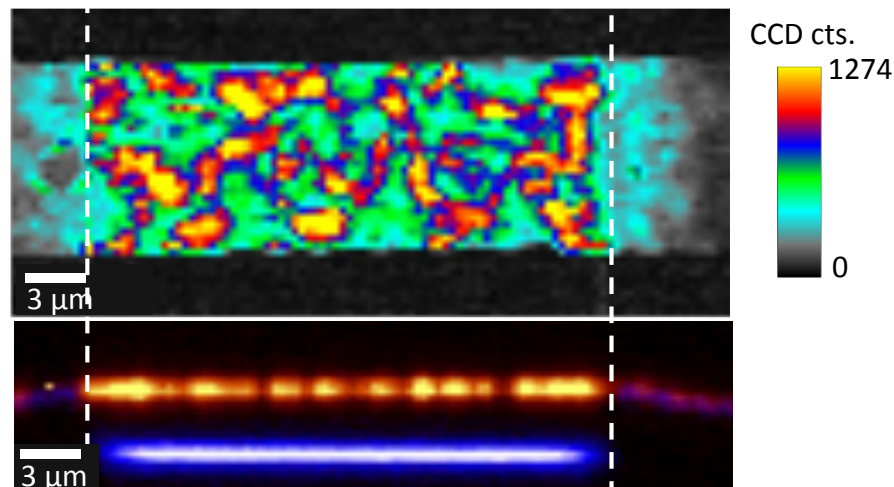
Other applications

Suspended 3 layer graphene over a trench



SEM image (45° tilt angle)

Area map: 2D-band intensity



Cross-section:

2D-band (red/yellow) and Si (blue) intensity

Further applications:

- Burried 2D materials (GBT^[10], devices with dielectric layer covering, burried strained layers,...)
- Layer stacks (identify the materials and check for intact layers after fabrication)
- Graphene nano reactors^[11]

[10] S. Vaziri *et al.*, *Nano Lett.*, vol. 13, no. 4, pp. 1435–1439, Apr. 2013.

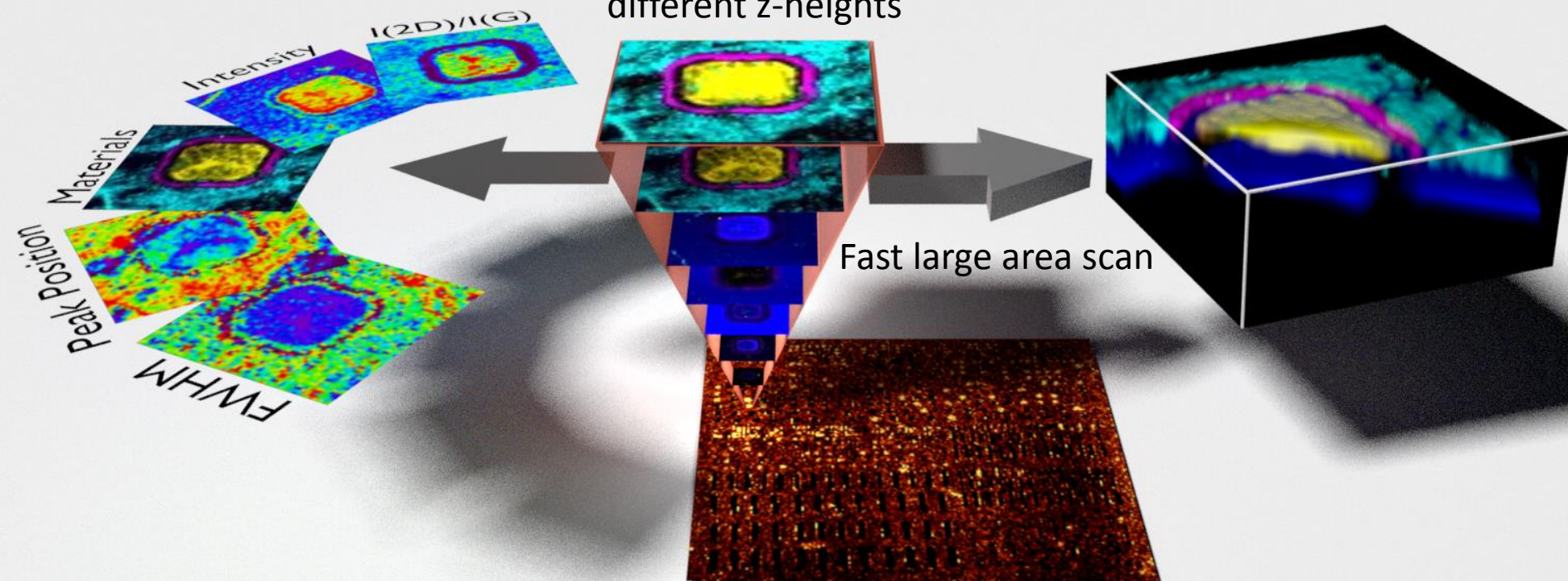
[11] B. Ding *et al.*, *Chem. A*, vol. 1, no. 4, pp. 1096–1101, Dec. 2012.

Conclusion

Depth dependent layer analysis

Image stack at different z-heights

Raman tomography images



- ☹️ System dependent resolution not high enough for layer thickness measurement
- 😊 non-invasive
- 😊 Detection to different materials
- 😊 Depth dependent analysis

Acknowledgement



BMBF Project: #03XP0006C



WITec: Thomas Dieing

Graphenea: Alba Centeno, Amaia Zurutuza





**Thank you very much
for your attention**